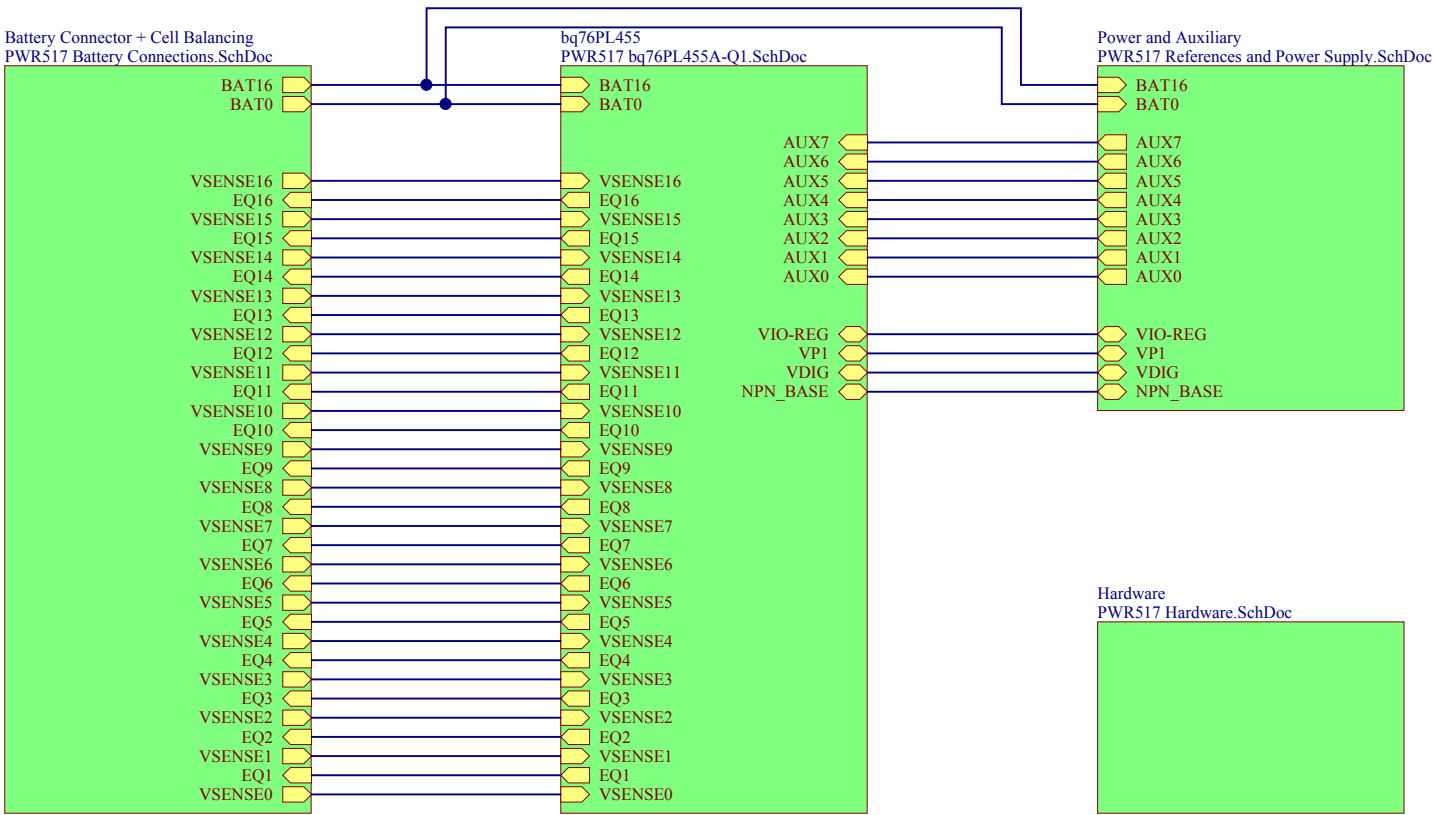
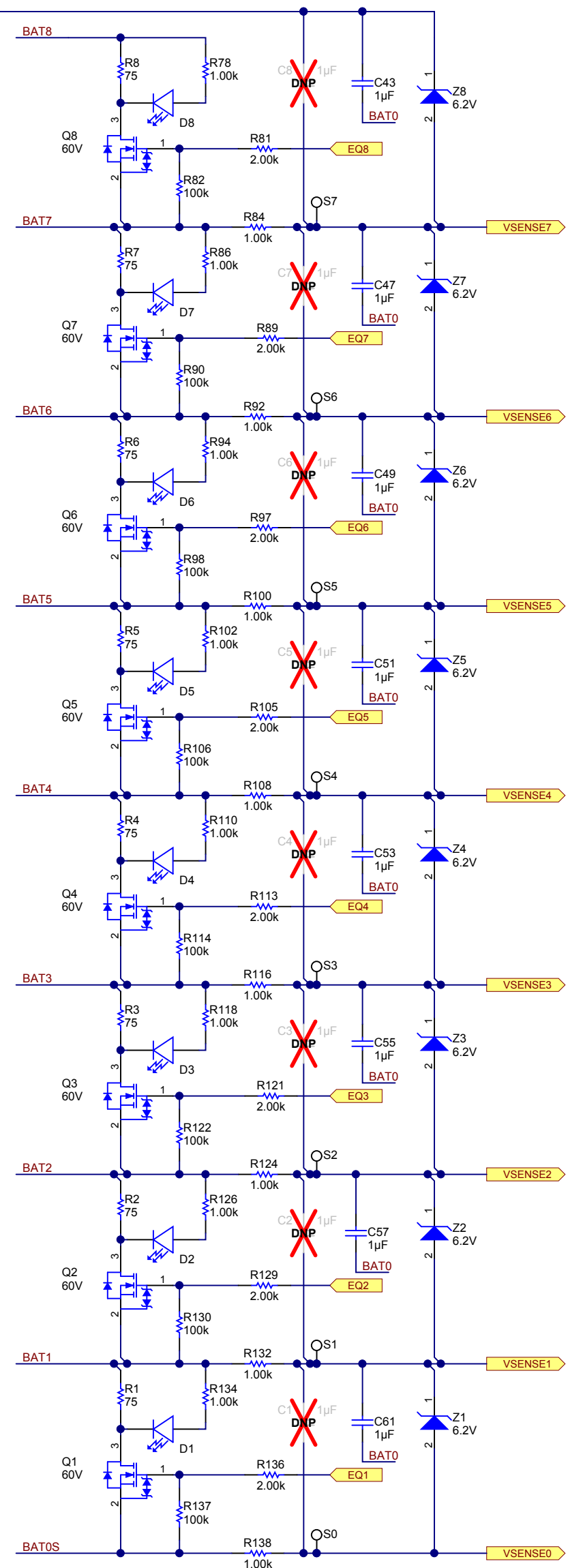
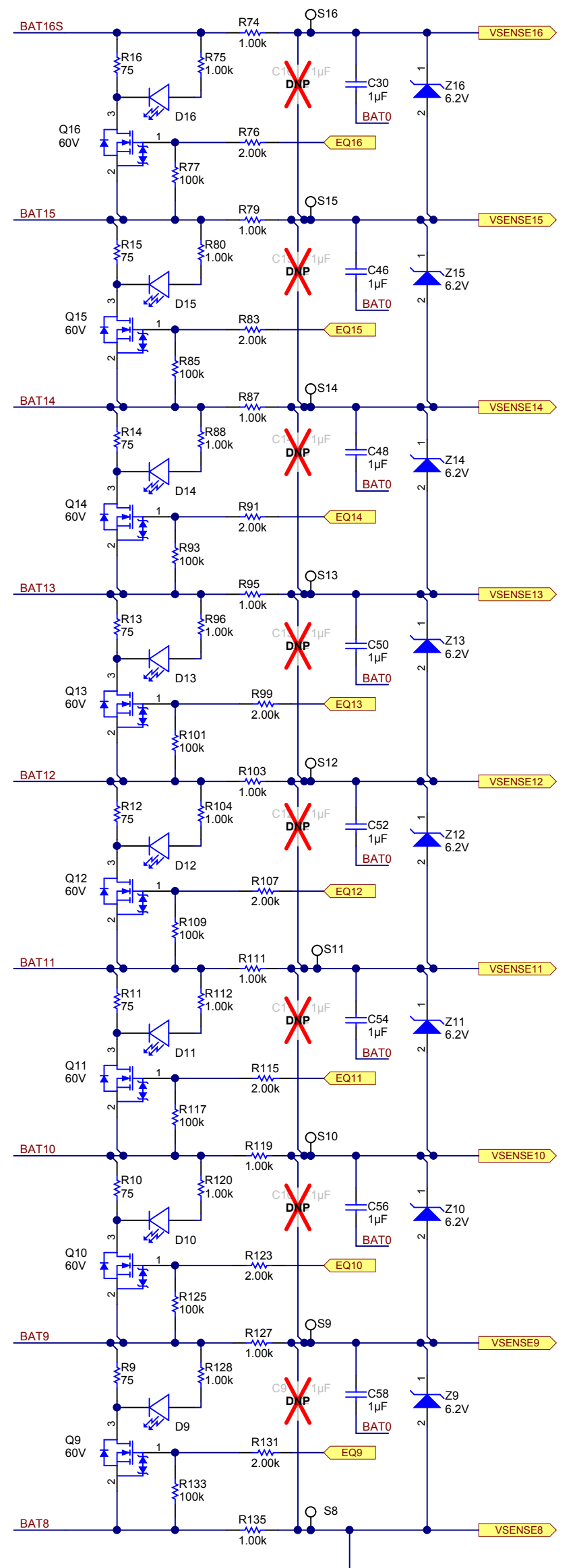
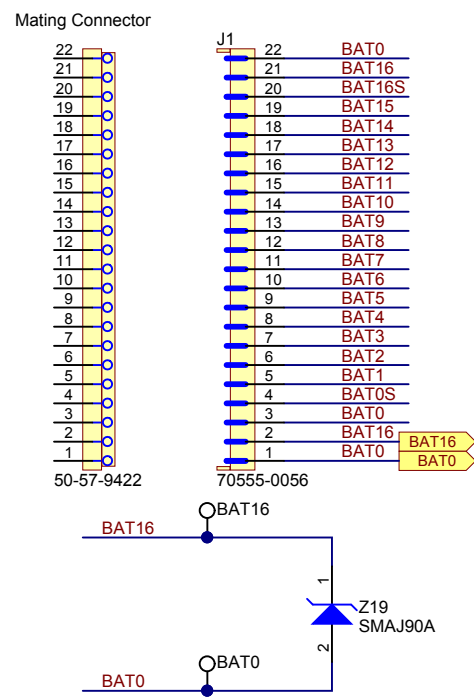
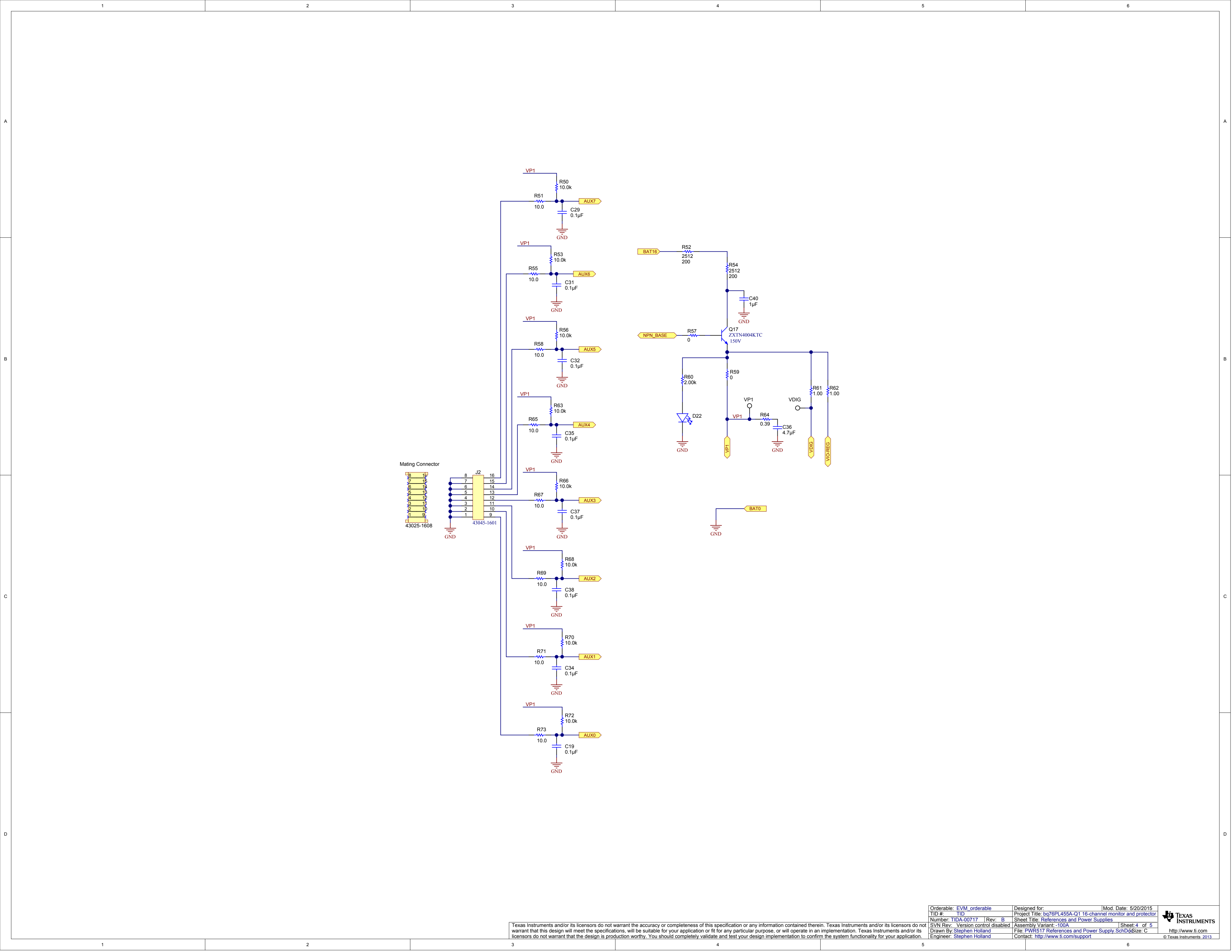


Revision History	
Revision	Notes
A	Release Version
B	Changed to common GND Increased C33 package size Moved zener diodes close to input pins









FID1



FID2

H1

NY PMS 440 0025 PH

H5

1902C

H2

NY PMS 440 0025 PH

H6

1902C

PCB Number: TIDA-00717
PCB Rev: B

PCB
LOGO

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H3

NY PMS 440 0025 PH

H7

1902C

H4

NY PMS 440 0025 PH

H8

1902C

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Orderable: EVM_orderable		Designed for:		Mod. Date: 5/20/2015	
TID #: TID		Project Title: bq76PL455A-Q1 16-channel monitor and protector			
Number: TIDA-00717		Rev: B		Sheet Title: Hardware	
SVN Rev: Version control disabled		Assembly Variant: -100A			Sheet: 5 of 5
Drawn By: Stephen Holland		File: PWR517 Hardware.SchDoc			Size: B
Engineer: Stephen Holland		Contact: http://www.ti.com/support			
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